



N-Channel Enhancement-Mode Vertical DMOS FET

Features

- ▶ Free from secondary breakdown
- ▶ Low power drive requirement
- ▶ Ease of paralleling
- ▶ Low C_{ISS} and fast switching speeds
- ▶ Excellent thermal stability
- ▶ Integral source-drain diode
- ▶ High input impedance and high gain

Applications

- ▶ Motor controls
- ▶ Converters
- ▶ Amplifiers
- ▶ Switches
- ▶ Power supply circuits
- ▶ Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

Ordering Information

| Part Number | Package Option | Packing |
|-----------------|----------------|-----------|
| VN0109N3-G | TO-92 | 1000/Bag |
| VN0109N3-G P002 | TO-92 | 2000/Reel |
| VN0109N3-G P003 | | |
| VN0109N3-G P005 | | |
| VN0109N3-G P013 | | |
| VN0109N3-G P014 | | |

-G denotes a lead (Pb)-free / RoHS compliant package.
 Contact factory for Wafer / Die availability.
 Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

Absolute Maximum Ratings

| Parameter | Value |
|-----------------------------------|-----------------------------------|
| Drain-to-source voltage | BV_{DSS} |
| Drain-to-gate voltage | BV_{DGS} |
| Gate-to-source voltage | $\pm 20V$ |
| Operating and storage temperature | $-55^{\circ}C$ to $+150^{\circ}C$ |

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Typical Thermal Resistance

| Package | θ_{ja} |
|---------|------------------|
| TO-92 | $132^{\circ}C/W$ |

General Description

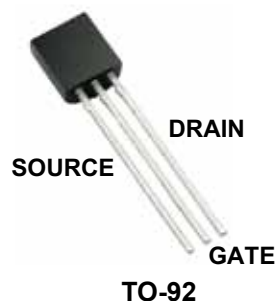
This enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

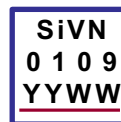
Product Summary

| BV_{DSS}/BV_{DGS} | $R_{DS(ON)}$ (max) | I_{DSS} (min) |
|---------------------|-----------------------|--------------------|
| 90V | 3.0Ω | 2.0A |

Pin Configuration



Product Marking



YY = Year Sealed
 WW = Week Sealed
 _____ = "Green" Packaging

Package may or may not include the following marks: Si or

TO-92

Thermal Characteristics

| Package | I_D (continuous) [†] | I_D (pulsed) | Power Dissipation @ $T_c = 25^\circ\text{C}$ | I_{DR} [†] | I_{DRM} |
|---------|------------------------------------|-------------------|---|-----------------------|-----------|
| TO-92 | 350mA | 2.0A | 1.0W | 350mA | 2.0A |

Notes:

[†] I_D (continuous) is limited by max rated T_j .

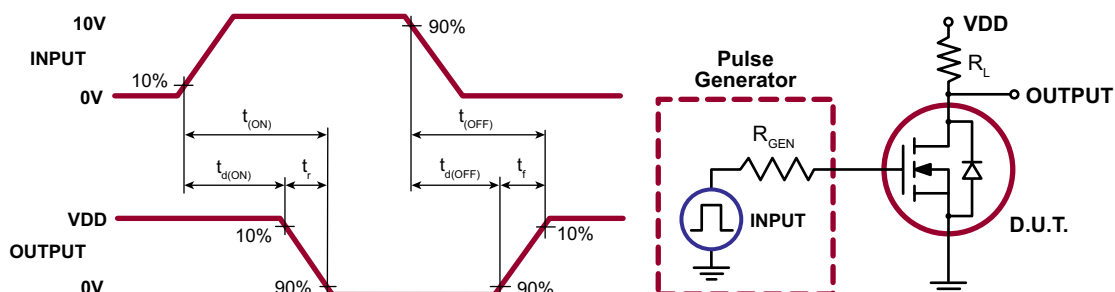
Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

| Sym | Parameter | Min | Typ | Max | Units | Conditions |
|---------------------|--|-----|------|------|---------------|---|
| BV_{DSS} | Drain-to-source breakdown voltage | 90 | - | - | V | $V_{GS} = 0V, I_D = 1.0mA$ |
| $V_{GS(th)}$ | Gate threshold voltage | 0.8 | - | 2.4 | V | $V_{GS} = V_{DS}, I_D = 1.0mA$ |
| $\Delta V_{GS(th)}$ | Change in $V_{GS(th)}$ with temperature | - | -3.8 | -5.5 | mV/°C | $V_{GS} = V_{DS}, I_D = 1.0mA$ |
| I_{GSS} | Gate body leakage | - | - | 100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| I_{DSS} | Zero gate voltage drain current | - | - | 1.0 | μA | $V_{GS} = 0V, V_{DS} = \text{Max Rating}$ |
| | | - | - | 100 | | $V_{DS} = 0.8 \text{ Max Rating}, V_{GS} = 0V, T_A = 125^\circ\text{C}$ |
| $I_{D(ON)}$ | On-state drain current | 0.5 | 1.0 | - | A | $V_{GS} = 5.0V, V_{DS} = 25V$ |
| | | 2.0 | 2.5 | - | | $V_{GS} = 10V, V_{DS} = 25V$ |
| $R_{DS(ON)}$ | Static drain-to-source on-state resistance | - | 3.0 | 5.0 | Ω | $V_{GS} = 5.0V, I_D = 250mA$ |
| | | - | 2.5 | 3.0 | | $V_{GS} = 10V, I_D = 1.0A$ |
| $\Delta R_{DS(ON)}$ | Change in $R_{DS(ON)}$ with temperature | - | 0.70 | 1.0 | %/°C | $V_{GS} = 10V, I_D = 1.0A$ |
| G_{FS} | Forward transductance | 300 | 450 | - | mmho | $V_{DS} = 25V, I_D = 500mA$ |
| C_{ISS} | Input capacitance | - | 55 | 65 | pF | $V_{GS} = 0V,$ $V_{DS} = 25V,$ $f = 1.0MHz$ |
| C_{OSS} | Common source output capacitance | - | 20 | 25 | | |
| C_{RSS} | Reverse transfer capacitance | - | 5.0 | 8.0 | | |
| $t_{d(ON)}$ | Turn-on delay time | - | 3.0 | 5.0 | ns | $V_{DD} = 25V,$ $I_D = 1.0A,$ $R_{GEN} = 25\Omega$ |
| t_r | Rise time | - | 5.0 | 8.0 | | |
| $t_{d(OFF)}$ | Turn-off delay time | - | 6.0 | 9.0 | | |
| t_f | Fall time | - | 5.0 | 8.0 | | |
| V_{SD} | Diode forward voltage drop | - | 1.2 | 1.8 | V | $V_{GS} = 0V, I_{SD} = 1.0A$ |
| t_{rr} | Reverse recovery time | - | 400 | - | ns | $V_{GS} = 0V, I_{SD} = 1.0A$ |

Notes:

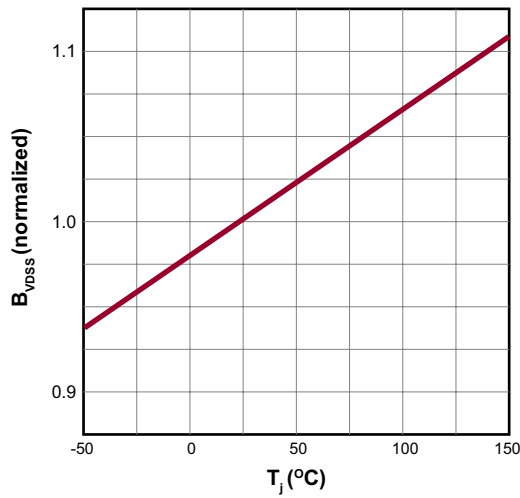
- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: $300\mu\text{s}$ pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

Switching Waveforms and Test Circuit

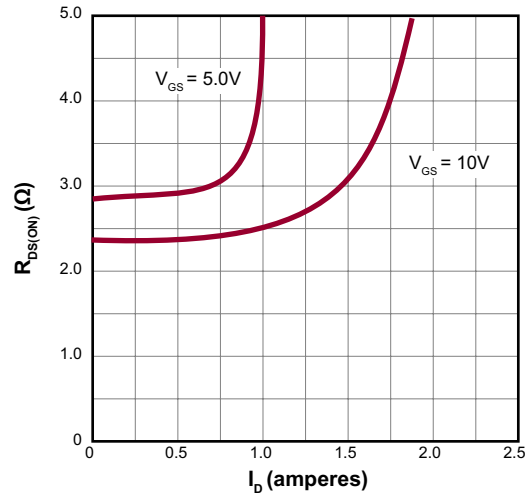


Typical Performance Curves

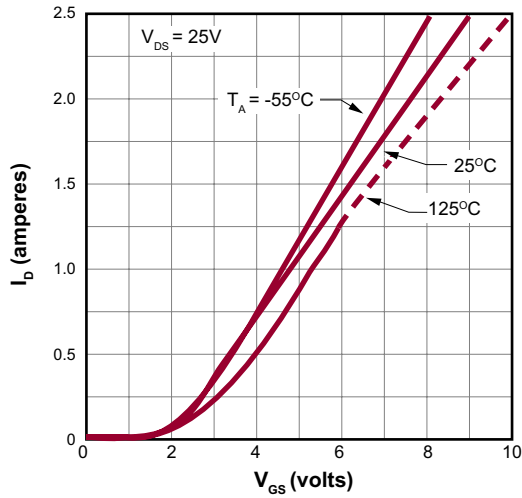
BV_{DSS} Variation with Temperature



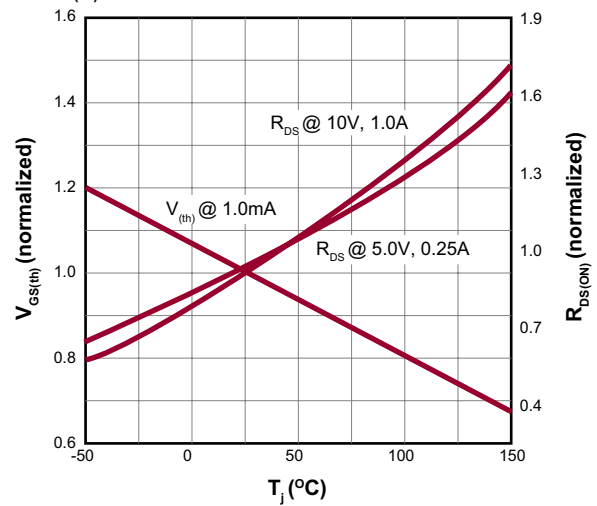
On-Resistance vs. Drain Current



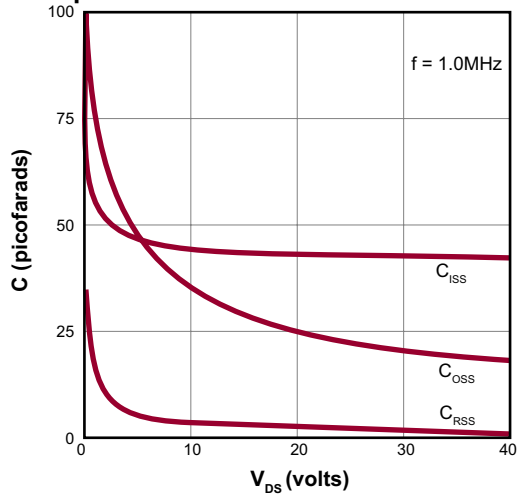
Transfer Characteristics



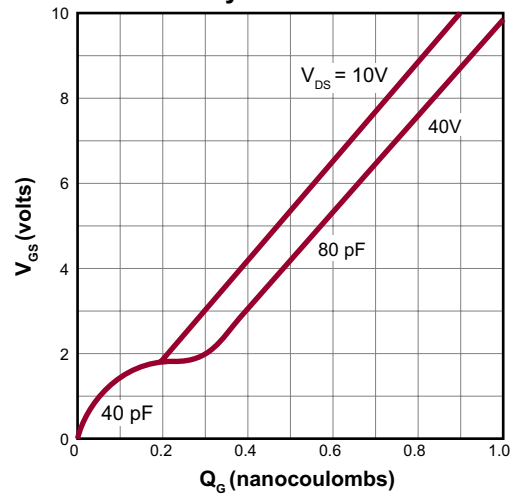
V_{GS(th)} and R_{DS} Variation with Temperature



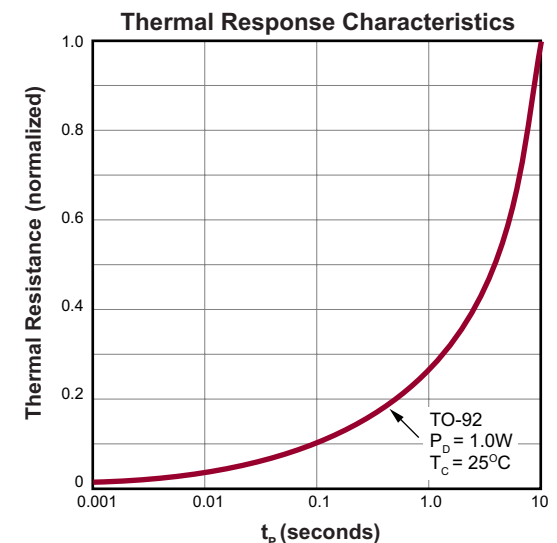
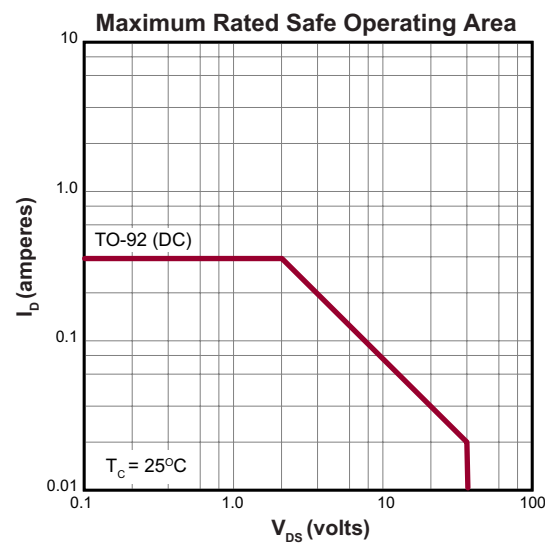
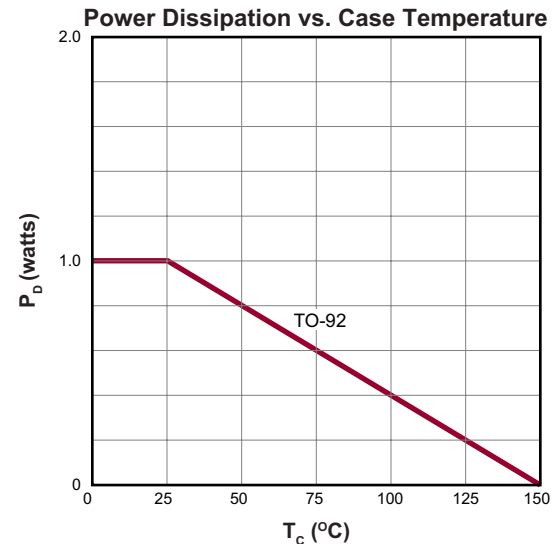
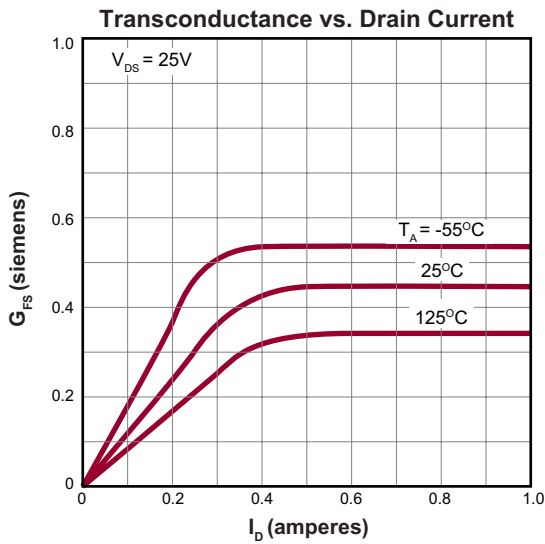
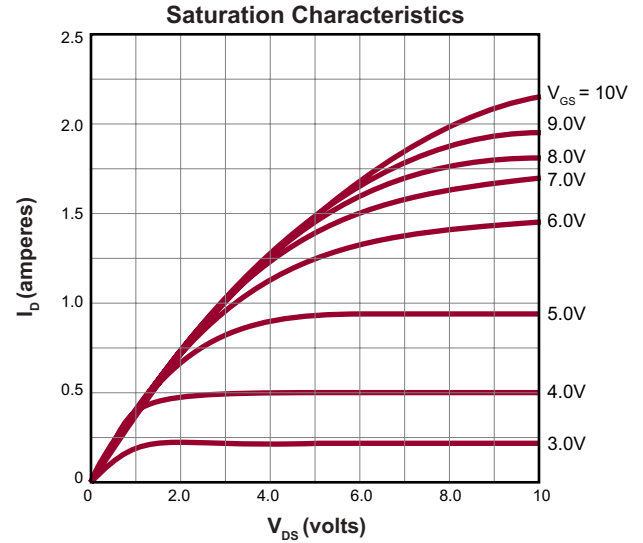
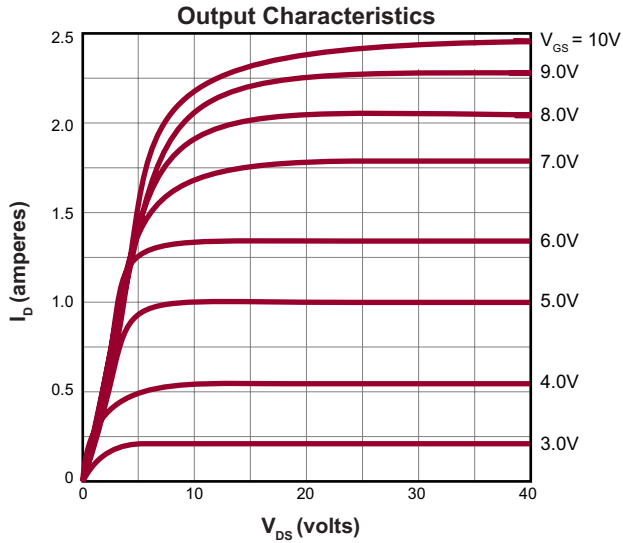
Capacitance vs. Drain-to-Source Voltage



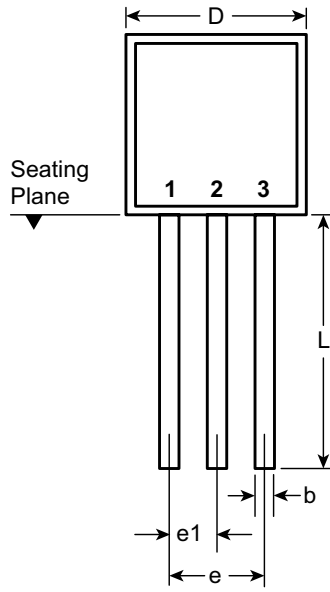
Gate Drive Dynamic Characteristics



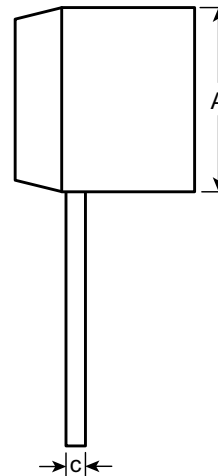
Typical Performance Curves (cont.)



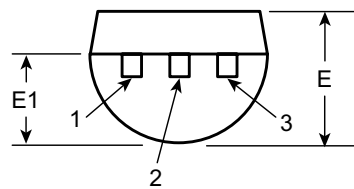
3-Lead TO-92 Package Outline (N3)



Front View



Side View



Bottom View

| Symbol | | A | b | c | D | E | E1 | e | e1 | L |
|------------------------|-----|------|-------------------|-------------------|------|------|------|------|------|-------|
| Dimensions (inches) | MIN | .170 | .014 [†] | .014 [†] | .175 | .125 | .080 | .095 | .045 | .500 |
| | NOM | - | - | - | - | - | - | - | - | - |
| | MAX | .210 | .022 [†] | .022 [†] | .205 | .165 | .105 | .105 | .055 | .610* |

JEDEC Registration TO-92.

* This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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